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20 V, 0.5 A low VF MEGA Schottky barrier rectifier Rev. 2 — 14 March 2012 Prod

Product data sheet

1. **Product profile**

1.1 General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a leadless ultra small SOD1608 (DFN1608D-2) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

1.2 Features and benefits

- Average forward current: I_{F(AV)} ≤ 0.5 A
- Reverse voltage: V_R ≤ 20 V
- Low forward voltage $V_F \le 410 \text{ mV}$
- Low reverse current

1.3 Applications

Quick reference data

Table 1

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply

1.4 Quick reference data

LED backlight for mobile application

- AEC-Q101 qualified Solderable side pads
- Package height typ. 0.37 mm
- Ultra small and leadless SMD plastic package
- Low power consumption applications
- Ultra high-speed switching
- Reverse polarity protection

Table 1.	Quick reference data						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{F(AV)}	average forward current	square wave; δ = 0.5; f = 20 kHz; T _{amb} ≤ 130 °C	<u>[1]</u>	-	-	0.5	A
		square wave; δ = 0.5; f = 20 kHz; T _{sp} ≤ 140 °C		-	-	0.5	A
V _R	reverse voltage	T _j = 25 °C		-	-	20	V
V _F	forward voltage	I_F = 500 mA; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 25 °C		-	360	410	mV
I _R	reverse current	V _R = 10 V; T _j = 25 °C		-	30	130	μA
t _{rr}	reverse recovery time	I_{R} = 0.5 A; I_{F} = 0.5 A; $I_{R(meas)}$ = 0.1 A; T_{j} = 25 $^{\circ}\mathrm{C}$		-	3	-	ns

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al₂O₃, standard footprint.



20 V, 0.5 A low VF MEGA Schottky barrier rectifier

2. Pinning information

Table 2.	Pinning			
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode ^[1]		. 64 -
2	A	anode		1 <u>-</u> 2 sym001
			Transparent top view	
			SOD1608 (DFN1608D-2)	

[1] The marking bar indicates the cathode.

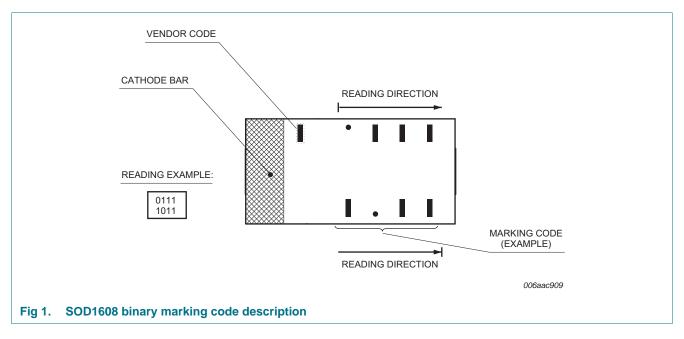
3. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
PMEG2005EPK	DFN1608D-2	Leadless ultra small plastic package; 2 terminals	SOD1608			

4. Marking

Table 4.Marking codes

Type number	Marking code
PMEG2005EPK	1000 0000



20 V, 0.5 A low VF MEGA Schottky barrier rectifier

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Мах	Unit
V _R	reverse voltage	T _j = 25 °C		-	20	V
I _F	forward current	T _{sp} ≤ 135 °C		-	0.7	А
I _{F(AV)}	average forward current	square wave; δ = 0.5; f = 20 kHz; T _{amb} ≤ 130 °C	<u>[1]</u>	-	0.5	A
		square wave; δ = 0.5; f = 20 kHz; T _{sp} ≤ 140 °C		-	0.5	A
I _{FRM}	repetitive peak forward current	t _p ≤ 1 ms; δ ≤ 0.5		-	2	А
I _{FSM}	non-repetitive peak forward current	square wave; $t_p = 8 \text{ ms}$; $T_{j(init)} = 25 \text{ °C}$		-	3	A
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[2]	-	390	mW
			[3]	-	830	mW
			<u>[1]</u>	-	1470	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al₂O₃, standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air [1][2]	[1][2]	-	-	320	K/W
			-	-	150	K/W	
			[1][4]	-	-	85	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		<u>[5]</u>	-	-	20	K/W

 For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

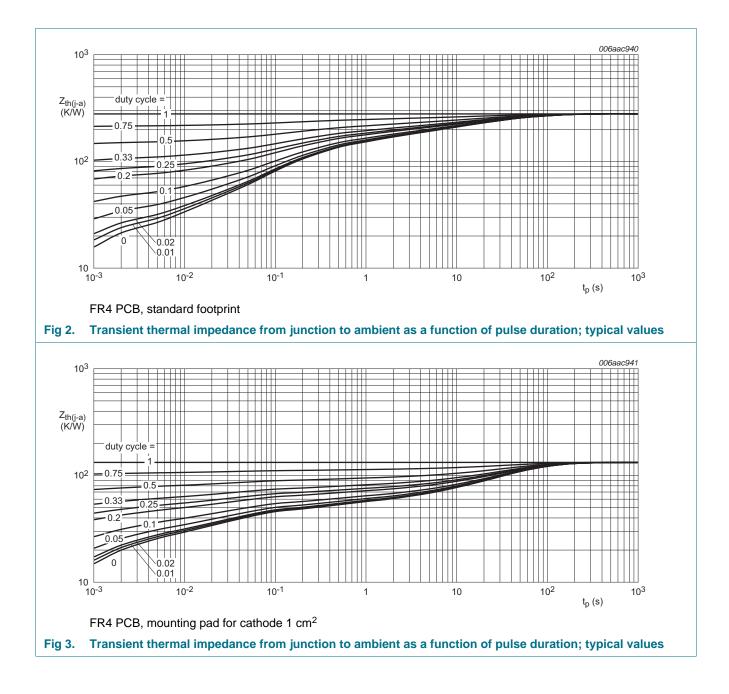
[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

[4] Device mounted on a ceramic PCB, AI_2O_3 , standard footprint.

[5] Soldering point of cathode tab.

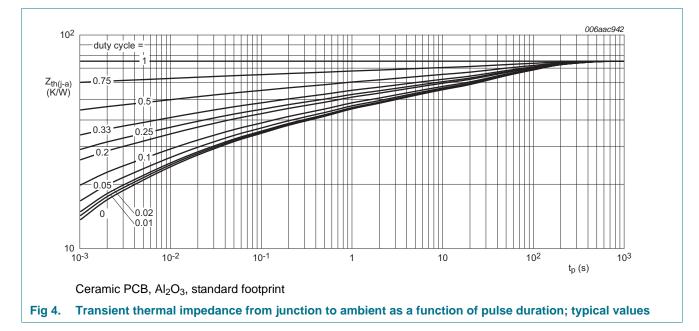
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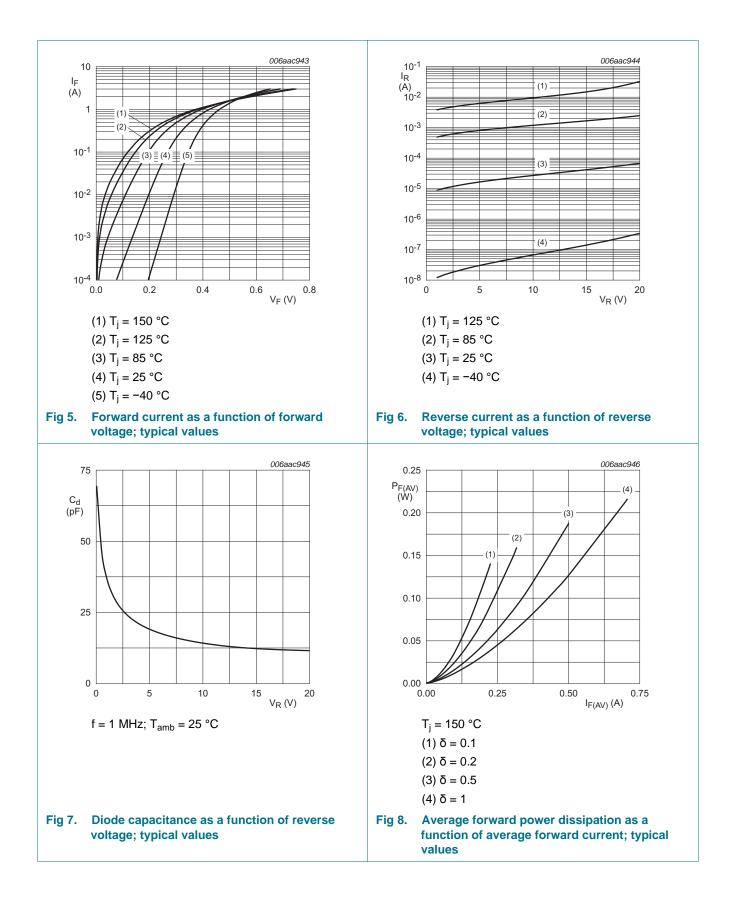


7. Characteristics

Table 7.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _F	forward voltage	I_F = 100 mA; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 25 °C	-	270	300	mV
		I_F = 500 mA; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 25 °C	-	360	410	mV
I _R	reverse current	V _R = 10 V; T _j = 25 °C	-	30	130	μA
		V _R = 20 V; T _j = 25 °C	-	70	300	μA
C _d	diode capacitance	V _R = 1 V; f = 1 MHz; T _j = 25 °C	-	35	-	pF
		V _R = 10 V; f = 1 MHz; T _j = 25 °C	-	13	-	pF
t _{rr}	reverse recovery time	$ I_{\text{F}} = 0.5 \text{ A}; I_{\text{R}} = 0.5 \text{ A}; I_{\text{R(meas)}} = 0.1 \text{ A}; \\ T_{\text{j}} = 25 ^{\circ}\text{C} $	-	3	-	ns
V_{FRM}	peak forward recovery voltage	$I_F = 0.5 \text{ A}; \text{ d}I_F/\text{d}t = 20 \text{ mA/}\mu\text{s}; T_j = 25 ^\circ\text{C}$	-	380	-	mV

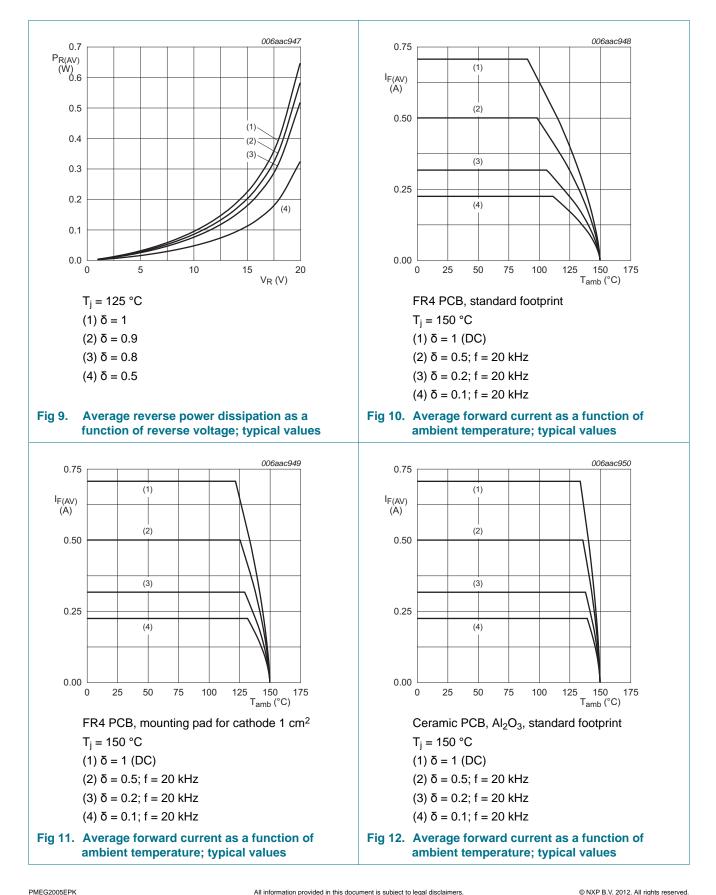
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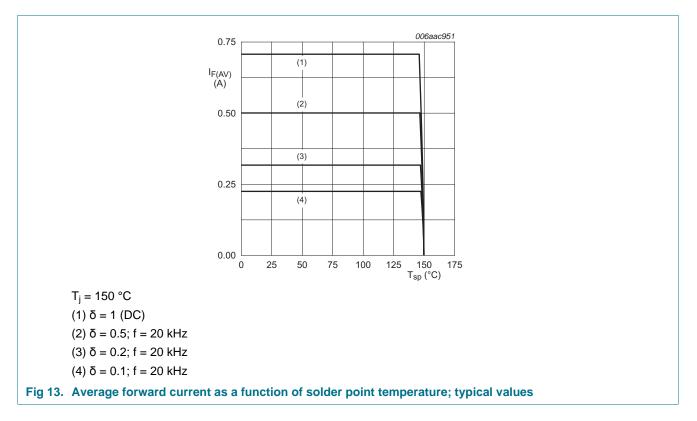
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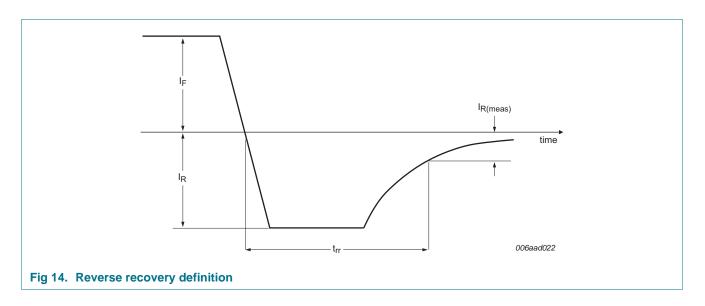


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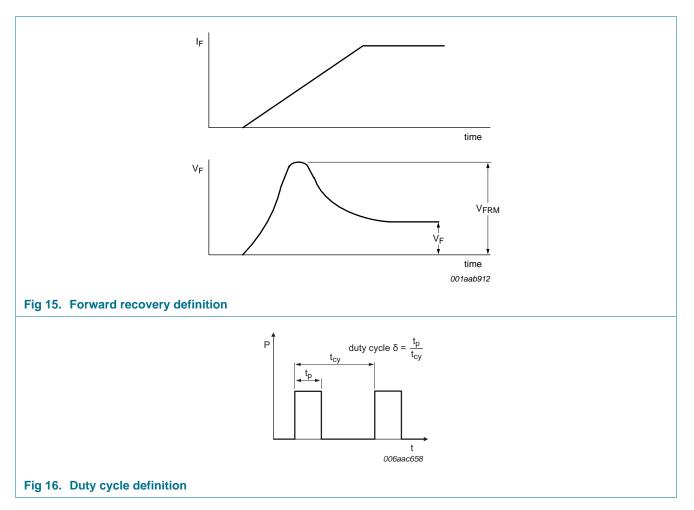
8. Test information



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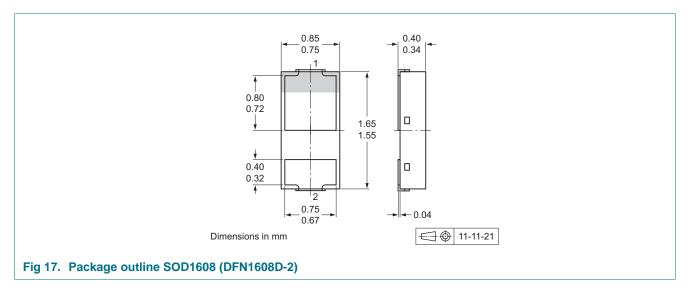
The current ratings for the typical waveforms are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current, $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

20 V, 0.5 A low VF MEGA Schottky barrier rectifier

Package outline 9.



10. Soldering

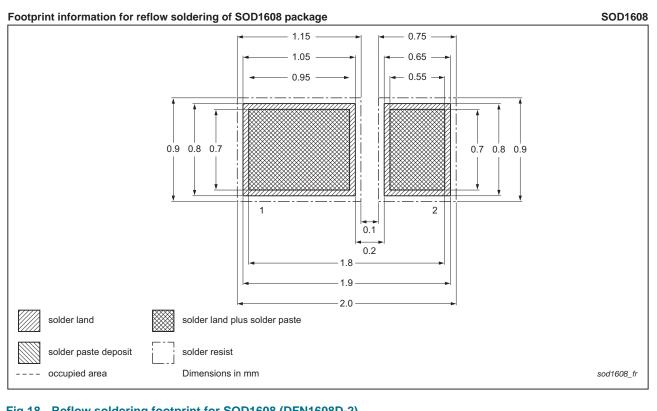


Fig 18. Reflow soldering footprint for SOD1608 (DFN1608D-2)

PMEG2005EPK **Product data sheet**

10 of 14

20 V, 0.5 A low VF MEGA Schottky barrier rectifier

11. Revision history

Table 8. Revision h	nistory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PMEG2005EPK v.2	20120314	Product data sheet	-	PMEG2005EPK v.1
Modifications:		lues": I _F corrected <u>stics"</u> : t _{rr} and V _{FRM} added <u>5</u> : added		
PMEG2005EPK v.1	20120112	Product data sheet	-	-

PMEG2005EPK Product data sheet

20 V, 0.5 A low VF MEGA Schottky barrier rectifier

12. Legal information

12.1 Data sheet status

Document status[1] [2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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Product data sheet

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20 V, 0.5 A low VF MEGA Schottky barrier rectifier

14. Contents

1	Product profile1
1.1	General description1
1.2	Features and benefits1
1.3	Applications1
1.4	Quick reference data1
2	Pinning information2
3	Ordering information2
4	Marking2
5	Limiting values
6	Thermal characteristics3
7	Characteristics5
8	Test information8
8.1	Quality information9
9	Package outline10
10	Soldering10
11	Revision history11
12	Legal information12
12.1	Data sheet status12
12.2	Definitions12
12.3	Disclaimers
12.4	Trademarks
13	Contact information13

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